

### 3.0x1.0mm RIGHT ANGLE SMD CHIP LED LAMP

### **Features**

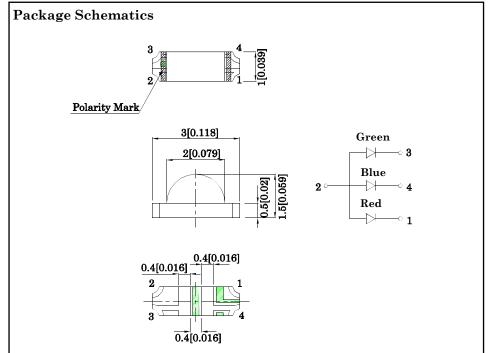
- $\bullet$  3.0 X 1.0 X 1.5mm right angle SMD LED
- Ideal for indication on hand held products
- Low current operation
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant







# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



### Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Red (AlGaIn P)	Green (InGaN)	Blue (InGa N)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	5	V
Forward Current I <sub>F</sub>		30	25	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\mathrm{FS}}$	185	185 150		mA
Power Dissipation I		75 102.5		120	mW
Electrostatic Discharge Threshold (HBM)		3000	450	250	V
Operating Temperature	$T_{A}$	-40 ~ +85			°C
Storage Temperature	Tstg	•			

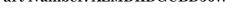
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)	Red (AlGaIn P)	Green (InGa N)	Blue (InGa N)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.95	3.3	3.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	4.1	4.0	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	50	50	μА
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λP	645*	515*	460*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λD	630*	525*	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	28	35	25	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	35	45	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
	Red	AlGaInP	_	55*	79*	645*	
XZMDKDGCBD56W	Green	InGaN	Water Clear	300*	497*	515*	150°
	Blue	InGaN	-	40*	69*	460*	

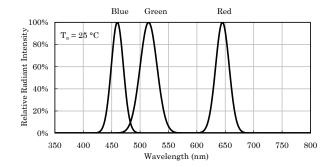
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

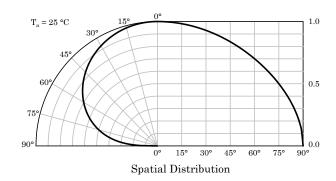
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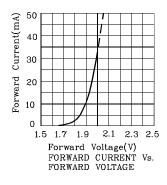


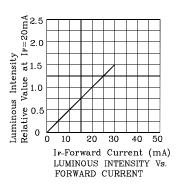


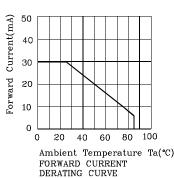


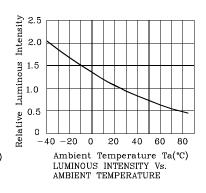


### Red

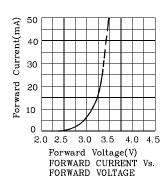


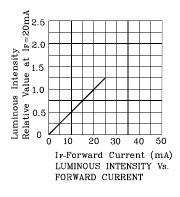


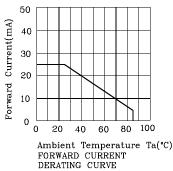


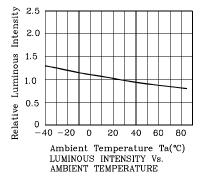


### **♦** Green

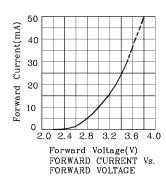


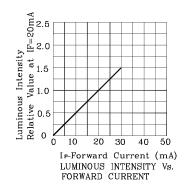


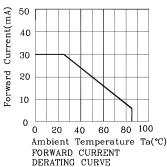


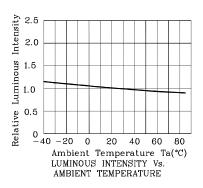


# **♦** Blue









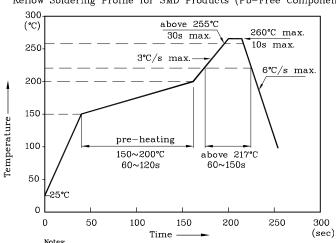
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## **♦** LED is recommended for reflow soldering and soldering profile is shown below.

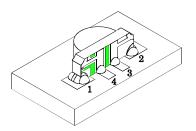
Reflow Soldering Profile for SMD Products (Pb-Free Components)



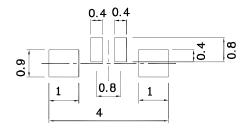
- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.

  2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

**♦** The device has a single mounting surface. The device must be mounted according to the specifications.



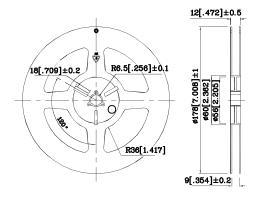
# **❖** Recommended Soldering Pattern (Units: mm; Tolerance: $\pm 0.1$ )



# **❖** Tape Specification (Units:mm)

# TAPE $4.0 \pm 0.1$ 75±0.1 $2.0 \pm 0.1$ $01.5 \pm 0.1$ $4.0 \pm 0.1$ 25±0.1 $8.0\pm 0.03$ 5±0.0

# Reel Dimension



### Remarks:

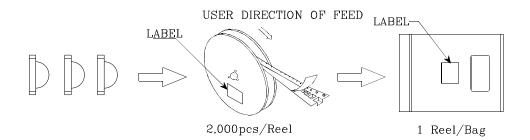
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

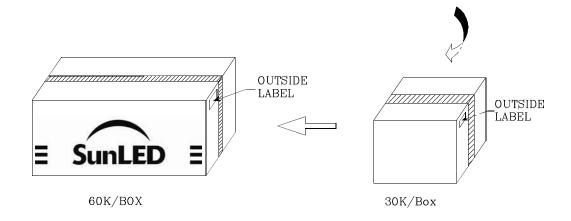
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

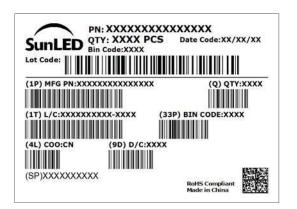
Note: Accuracy may depend on the sorting parameters.



# PACKING & LABEL SPECIFICATIONS







### TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at <a href="https://www.SunLEDusa.com/TechnicalNotes.asp">https://www.SunLEDusa.com/TechnicalNotes.asp</a>

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